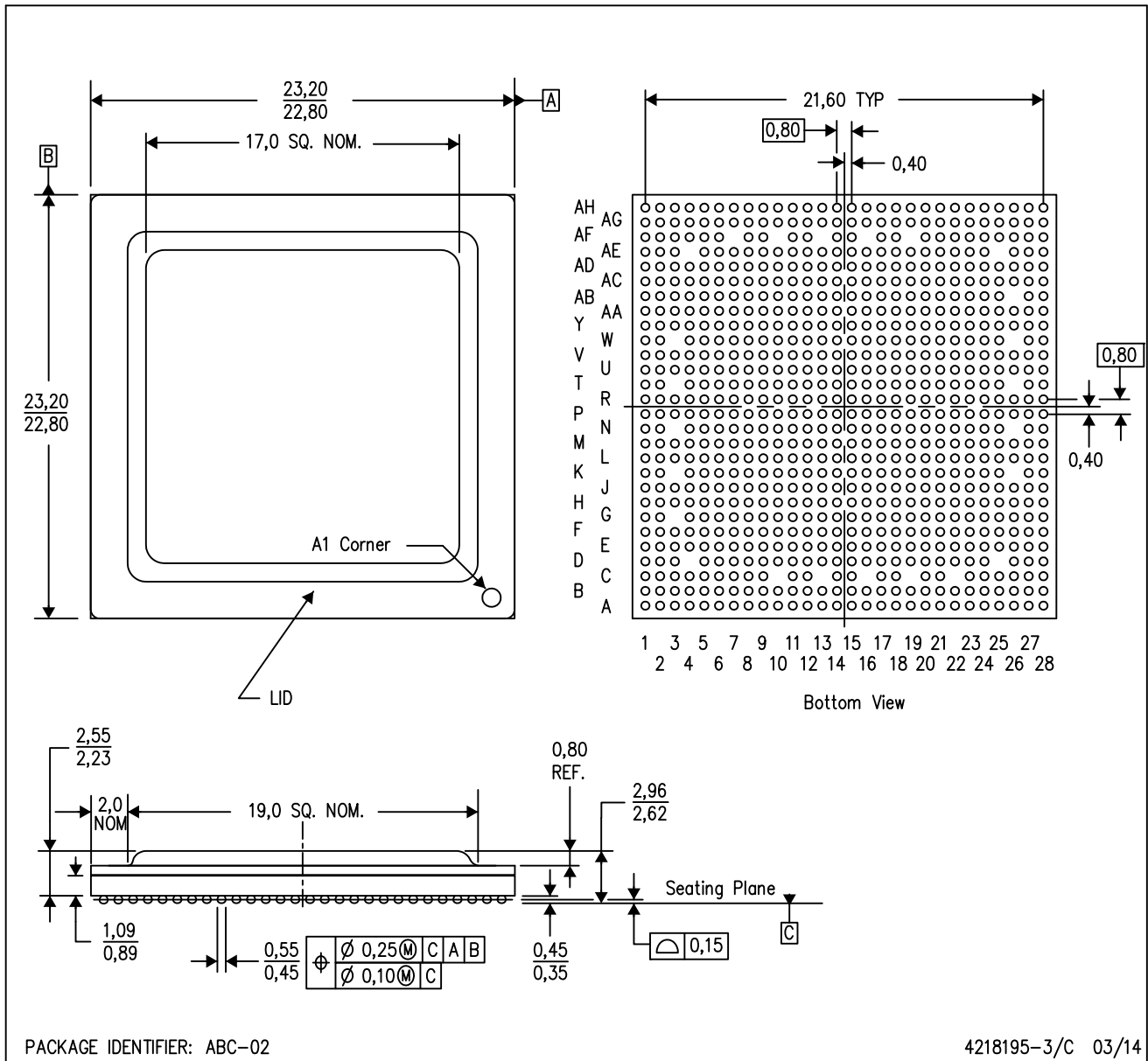


ABC (S-PBGA-N760)

PLASTIC BALL GRID ARRAY



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Flip chip application only.
  - D. Thermally enhanced plastic package with lid.
  - E. Pb-free die bump and solder ball.

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